



PHP30NQ15T

N-channel TrenchMOS standard level FET

Rev. 03 — 3 March 2010

Product data sheet

1. Product profile

1.1 General description

Standard level N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using TrenchMOS technology. This product is designed and qualified for use in computing, communications, consumer and industrial applications only.

1.2 Features and benefits

- Low conduction losses due to low on-state resistance
- Suitable for high frequency applications due to fast switching characteristics

1.3 Applications

- DC-to-DC convertors
- Switched-mode power supplies

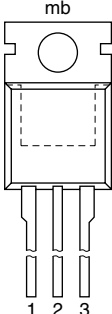
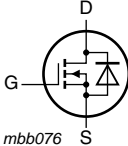
1.4 Quick reference data

Table 1. Quick reference

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{DS}	drain-source voltage	$T_j \geq 25\text{ °C}; T_j \leq 175\text{ °C}$	-	-	150	V
I_D	drain current	$T_{mb} = 25\text{ °C}; V_{GS} = 10\text{ V};$ see Figure 1 and 2	-	-	29	A
P_{tot}	total power dissipation	$T_{mb} = 25\text{ °C};$ see Figure 3	-	-	150	W
Dynamic characteristics						
Q_{GD}	gate-drain charge	$V_{GS} = 10\text{ V}; I_D = 30\text{ A};$ $V_{DS} = 120\text{ V}; T_j = 25\text{ °C};$ see Figure 13	-	20	27	nC
Static characteristics						
$R_{DS(on)}$	drain-source on-state resistance	$V_{GS} = 10\text{ V}; I_D = 15\text{ A};$ $T_j = 25\text{ °C};$ see Figure 11 and 12	-	60	63	m Ω

2. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		
2	D	drain		
3	S	source		
mb	D	mounting base; connected to drain		

SOT78 (TO-220AB)

3. Ordering information

Table 3. Ordering information

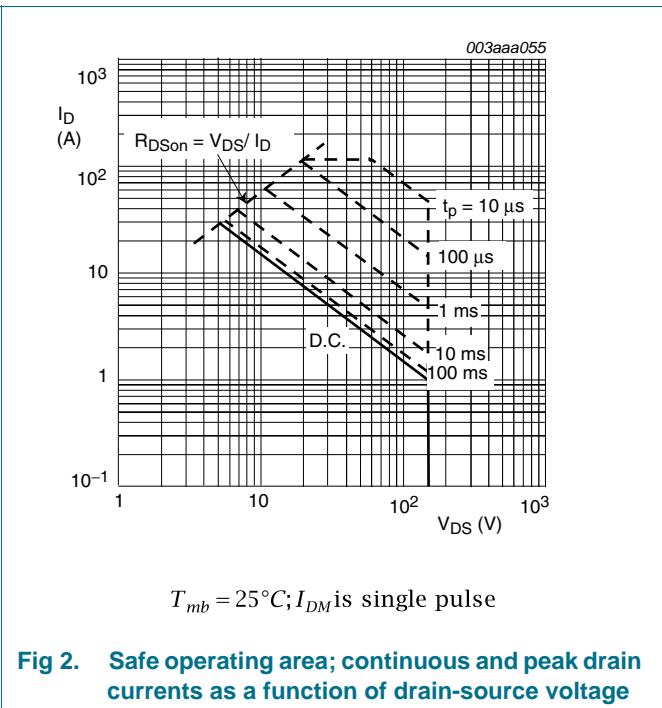
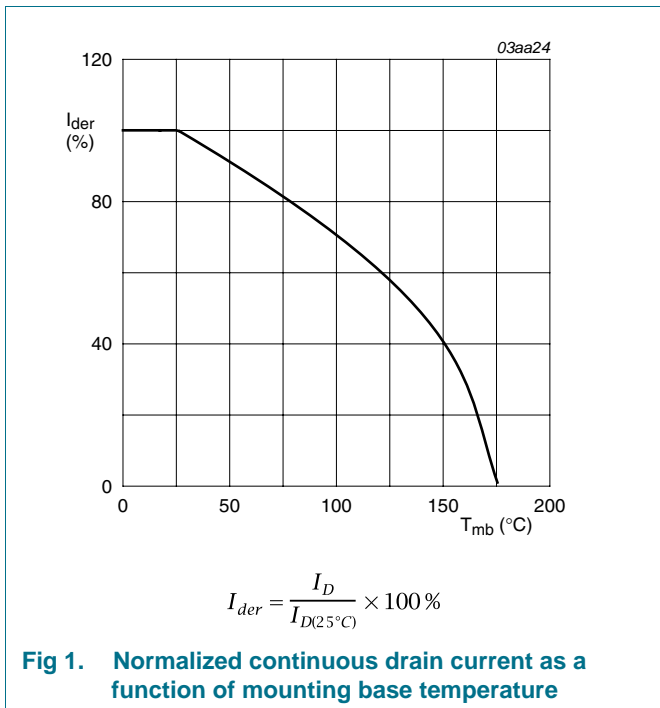
Type number	Package		Version
	Name	Description	
PHP30NQ15T	TO-220AB	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78

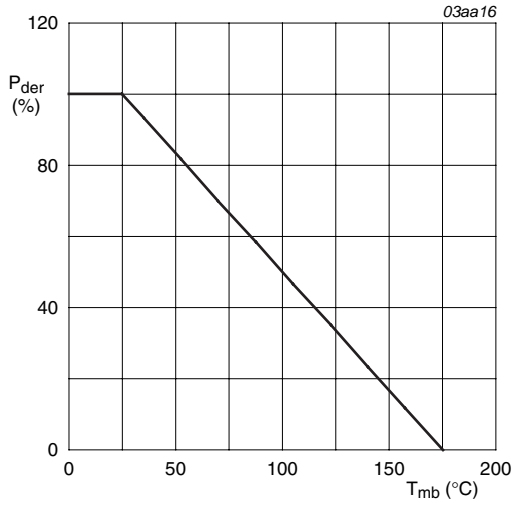
4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

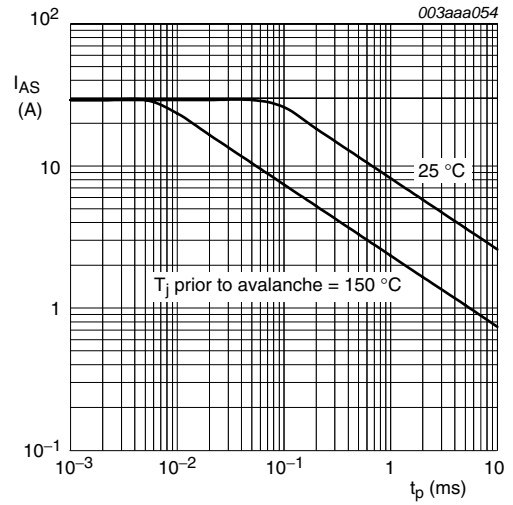
Symbol	Parameter	Conditions	Min	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C	-	150	V
V _{DGR}	drain-gate voltage	T _j ≥ 25 °C; T _j ≤ 175 °C; R _{GS} = 20 kΩ	-	150	V
V _{GS}	gate-source voltage		-20	20	V
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; see Figure 1 and 2	-	29	A
		V _{GS} = 10 V; T _{mb} = 100 °C; see Figure 1	-	20	A
I _{DM}	peak drain current	t _p ≤ 10 μs; pulsed; T _{mb} = 25 °C; see Figure 2	-	116	A
P _{tot}	total power dissipation	T _{mb} = 25 °C; see Figure 3	-	150	W
T _{stg}	storage temperature		-55	175	°C
T _j	junction temperature		-55	175	°C
Source-drain diode					
I _S	source current	T _{mb} = 25 °C	-	29	A
I _{SM}	peak source current	t _p ≤ 10 μs; pulsed; T _{mb} = 25 °C	-	116	A
Avalanche ruggedness					
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	V _{GS} = 10 V; T _{j(initial)} = 25 °C; I _D = 26 A; V _{sup} ≤ 25 V; unclamped; R _{GS} = 50 Ω; t _p = 0.2 ms; see Figure 4	-	502	mJ
I _{AS}	non-repetitive avalanche current	V _{sup} ≤ 25 V; V _{GS} = 10 V; T _{j(initial)} = 25 °C; R _{GS} = 50 Ω; unclamped; see Figure 4	-	29	A





$$P_{der} = \frac{P_{tot}}{P_{tot(25^\circ C)}} \times 100\%$$

Fig 3. Normalized total power dissipation as a function of mounting base temperature



Unclamped inductive load; $V_{DS} \leq 25V$;
 $R_{GS} = 50\Omega$; $V_{GS} = 10V$; starting at $T_j = 25^\circ C$ and $150^\circ C$.

Fig 4. Non-repetitive avalanche ruggedness current as a function of pulse duration

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	see Figure 5	-	-	1	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient	vertical in still air	-	60	-	K/W

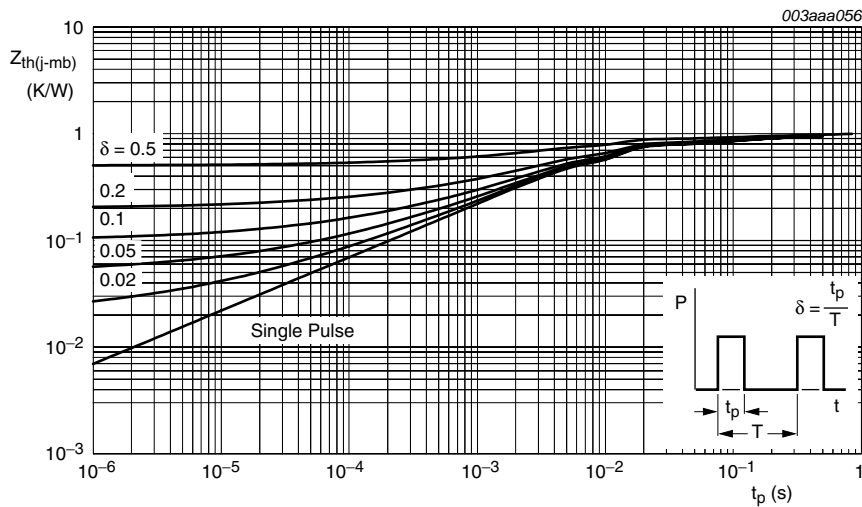
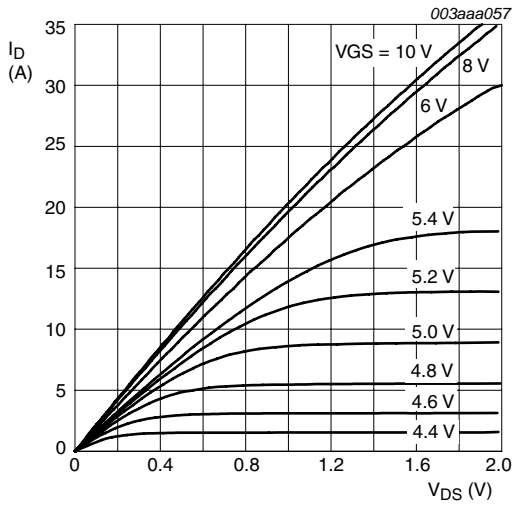


Fig 5. Transient thermal impedance from junction to mounting base as a function of pulse duration

6. Characteristics

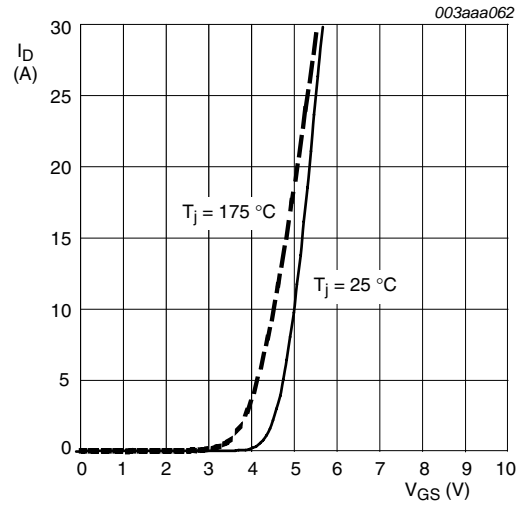
Table 6. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static characteristics						
$V_{(BR)DSS}$	drain-source breakdown voltage	$I_D = 250 \mu A$; $V_{GS} = 0 V$; $T_j = 25 \text{ }^\circ\text{C}$	150	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	$I_D = 1 \text{ mA}$; $V_{DS} = V_{GS}$; $T_j = 25 \text{ }^\circ\text{C}$; see Figure 8	2	3	4	V
		$I_D = 1 \text{ mA}$; $V_{DS} = V_{GS}$; $T_j = 175 \text{ }^\circ\text{C}$; see Figure 8	1	-	-	V
I_{DSS}	drain leakage current	$V_{DS} = 150 V$; $V_{GS} = 0 V$; $T_j = 25 \text{ }^\circ\text{C}$	-	0.05	10	μA
		$V_{DS} = 150 V$; $V_{GS} = 0 V$; $T_j = 175 \text{ }^\circ\text{C}$	-	-	500	μA
I_{GSS}	gate leakage current	$V_{GS} = 10 V$; $V_{DS} = 0 V$; $T_j = 25 \text{ }^\circ\text{C}$	-	0.02	100	nA
		$V_{GS} = -10 V$; $V_{DS} = 0 V$; $T_j = 25 \text{ }^\circ\text{C}$	-	0.02	100	nA
$R_{DS(on)}$	drain-source on-state resistance	$V_{GS} = 10 V$; $I_D = 15 A$; $T_j = 175 \text{ }^\circ\text{C}$; see Figure 11 and 12	-	-	176	m Ω
		$V_{GS} = 10 V$; $I_D = 15 A$; $T_j = 25 \text{ }^\circ\text{C}$; see Figure 11 and 12	-	60	63	m Ω
Dynamic characteristics						
$Q_{G(tot)}$	total gate charge	$I_D = 30 A$; $V_{DS} = 120 V$; $V_{GS} = 10 V$; $T_j = 25 \text{ }^\circ\text{C}$; see Figure 13	-	55	-	nC
Q_{GS}	gate-source charge		-	10	-	nC
Q_{GD}	gate-drain charge		-	20	27	nC
C_{iss}	input capacitance	$V_{DS} = 25 V$; $V_{GS} = 0 V$; $f = 1 \text{ MHz}$; $T_j = 25 \text{ }^\circ\text{C}$; see Figure 14	-	2390	-	pF
C_{oss}	output capacitance		-	240	-	pF
C_{rSS}	reverse transfer capacitance		-	98	-	pF
$t_{d(on)}$	turn-on delay time	$V_{DS} = 75 V$; $R_L = 2.7 \Omega$; $V_{GS} = 10 V$; $R_{G(ext)} = 5.6 \Omega$; $T_j = 25 \text{ }^\circ\text{C}$	-	14	-	ns
t_r	rise time		-	50	-	ns
$t_{d(off)}$	turn-off delay time		-	48	-	ns
t_f	fall time		-	38	-	ns
Source-drain diode						
V_{SD}	source-drain voltage	$I_S = 25 A$; $V_{GS} = 0 V$; $T_j = 25 \text{ }^\circ\text{C}$; see Figure 15	-	0.9	1.2	V
t_{rr}	reverse recovery time	$I_S = 20 A$; $di_S/dt = -100 A/\mu s$; $V_{GS} = 0 V$; $V_{DS} = 25 V$; $T_j = 25 \text{ }^\circ\text{C}$	-	105	-	ns
Q_r	recovered charge		-	0.55	-	μC



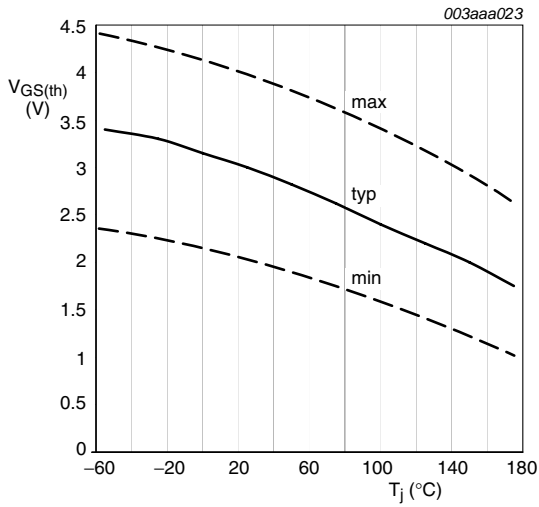
$T_j = 25^\circ\text{C}$

Fig 6. Output characteristics: drain current as a function of drain-source voltage; typical values



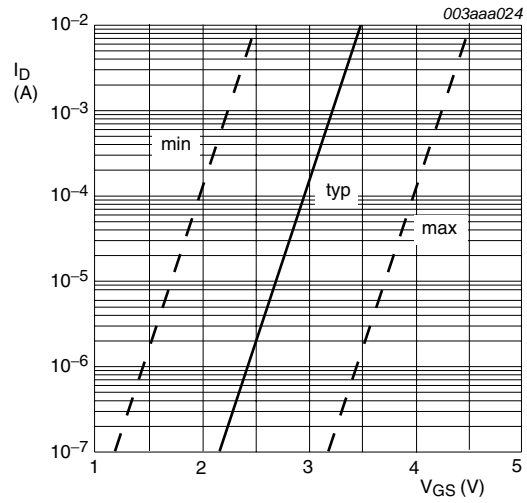
$T_j = 25^\circ\text{C}$ and 175°C ; $V_{DS} > I_D \times R_{DSon}$

Fig 7. Transfer characteristics: drain current as a function of gate-source voltage; typical values



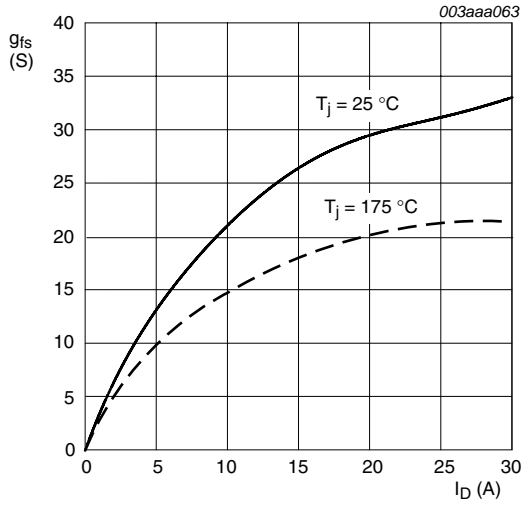
$I_D = 1\text{mA}$; $V_{DS} = V_{GS}$

Fig 8. Gate-source threshold voltage as a function of junction temperature



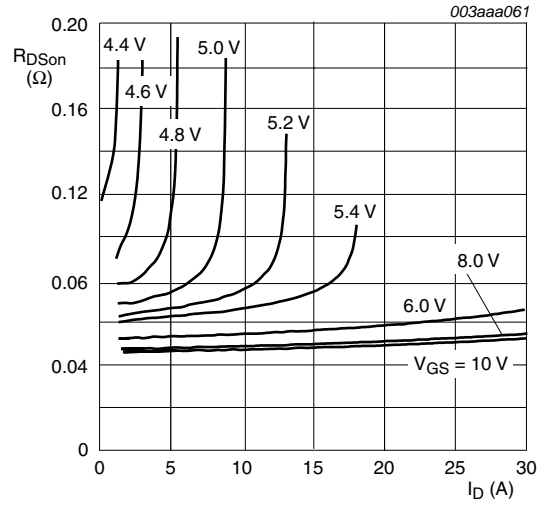
$T_j = 25^\circ\text{C}$

Fig 9. Sub-threshold drain current as a function of gate-source voltage



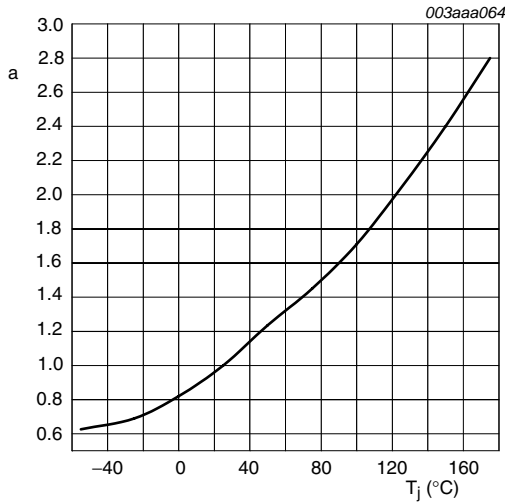
$T_j = 25^\circ\text{C}$ and $175^\circ\text{C}; V_{DS} > I_D \times R_{DSon}$

Fig 10. Forward transconductance as a function of drain current; typical values



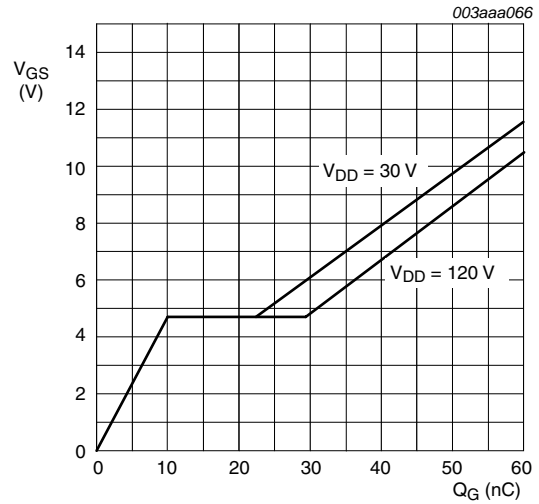
$T_j = 25^\circ\text{C}$

Fig 11. Drain-source on-state resistance as a function of drain current; typical values



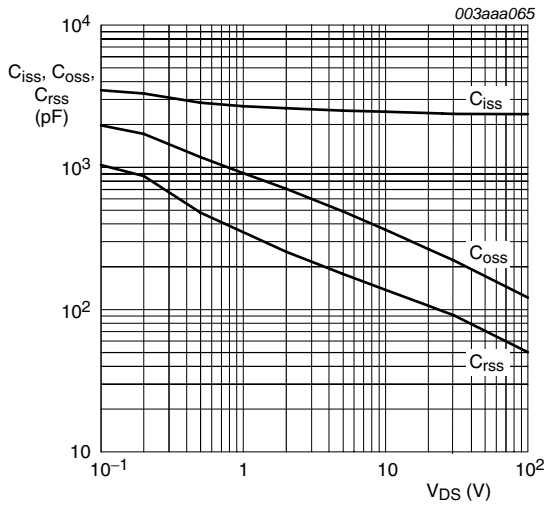
$$a = \frac{R_{DSon}}{R_{DSon(25^\circ\text{C})}}$$

Fig 12. Normalized drain-source on-state resistance factor as a function of junction temperature



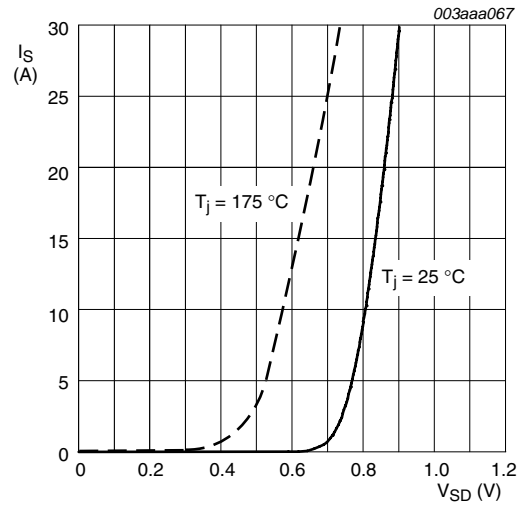
$I_D = 30\text{ A}; V_{DS} = 30\text{ V}$ and 120 V

Fig 13. Gate-source voltage as a function of gate charge; typical values



$V_{GS} = 0V; f = 1MHz$

Fig 14. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values



$T_j = 25^\circ C$ and $175^\circ C; V_{GS} = 0V$

Fig 15. Source current as a function of source-drain voltage; typical values

7. Package outline

Plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB

SOT78

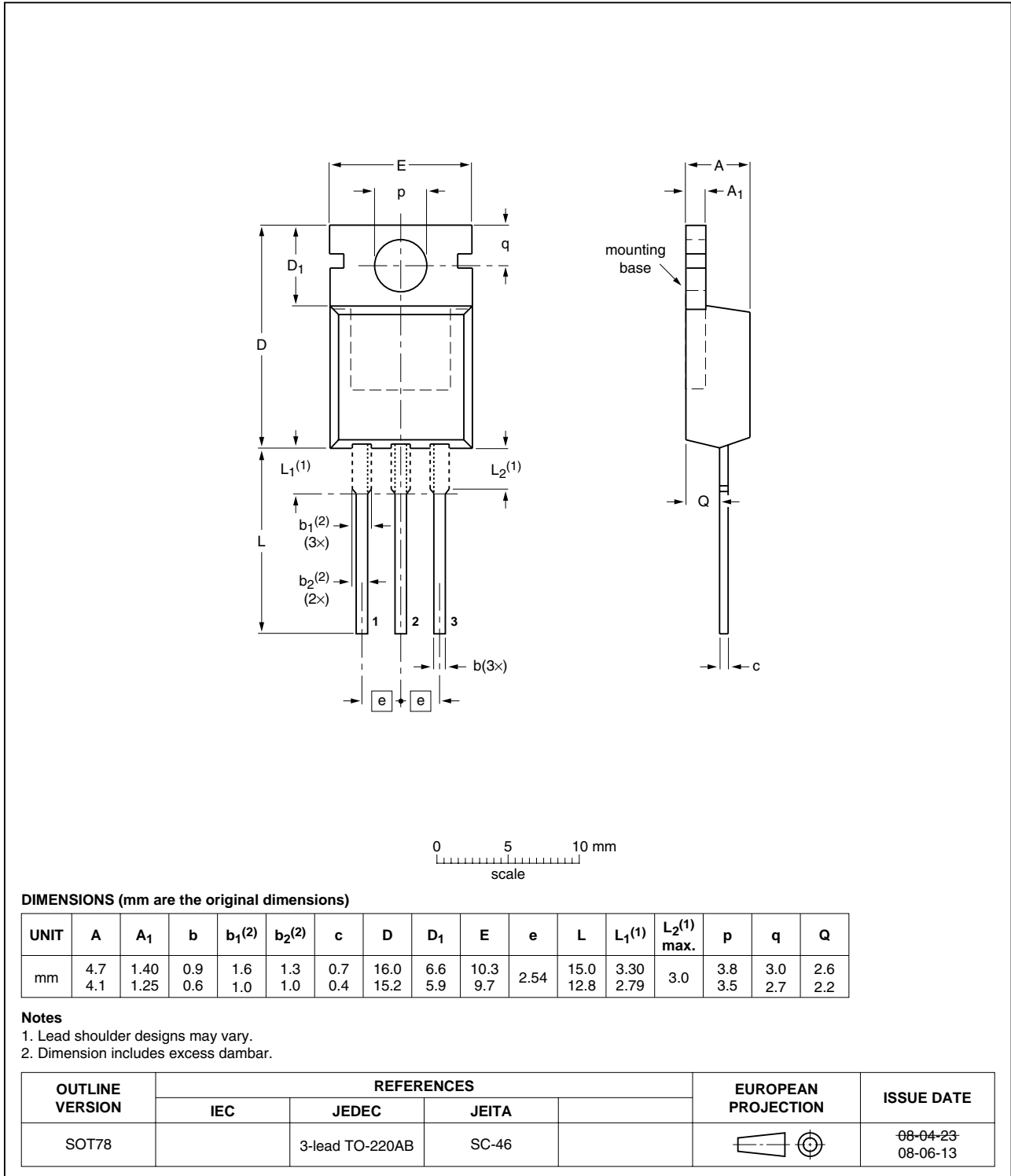


Fig 16. Package outline SOT78 (TO-220AB)

8. Revision history

Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PHP30NQ15T_3	20100303	Product data sheet	-	PHB_PHP30NQ15T-02
Modifications:		<ul style="list-style-type: none">• The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.• Legal texts have been adapted to the new company name where appropriate.• Typenumber PHP30NQ15T separated from data sheet PHB_PHP30NQ15T-02.		
PHB_PHP30NQ15T-02 (9397 750 08037)	20010312	Product specification	-	PHB_PHP30NQ15T_1
PHB_PHP30NQ15T_1	19990801	Product specification	-	-

9. Legal information

9.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nexperia.com>.

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